Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

Listing of Claims:

1. (Currently Amended) A method for manufacturing an organic electro-luminescent device, the method comprising the steps of:

providing a substrate;

arranging at least one first electrode on the substrate, the first electrode being made of a first conductive film to form a subassembly;

forming a plurality of insulating ribs on the first electrode;

forming at least one organic layer on the subassembly, the at least one organic layer being made of an organic electro-luminescent medium, so that the at least one organic layer covers the ~~at least one~~ first electrode;

forming a second conductive film over the at least one organic layer; and

removing at least one portion of the second conductive film using a radiation method to create second electrodes that are electrically isolated from each other; wherein removing the at least one portion of the second conductive film includes removing a portion of the second conductive film from over the insulating ribs and removing at least a portion of the insulating ribs.

2. (Currently Amended) A method for manufacturing a device according to claim 1, wherein the step of arranging at least one first electrode comprises arranging a plurality of electrodes in a stripe-like manner to form lower stripe-like electrodes.

3. (Currently Amended) A method for manufacturing a device according to claim 2, wherein the step of removing at least one portion of the second conductive film comprises

creating stripe-like electrodes extending in a direction perpendicular to the lower stripe-like electrodes.

4. (Currently Amended) A method for manufacturing a device according to claim 1, wherein the step of removing at least one portion of the second conductive film using a radiation method comprises using a laser beam.

5. (Currently Amended) A method for manufacturing a device according to claim 1, wherein the step of removing at least one portion of the second conductive film using a radiation method comprises using an electron beam.

6. (Currently Amended) A method for manufacturing a device according to claim 1, wherein the step of removing at least one portion of the second conductive film comprises removing at least a portion of the organic layer.

7. (Currently Amended) A method for manufacturing a device according to claim 1, wherein the step of forming a second conductive film is carried out by vacuum deposition.

8. (Canceled)

9. (Currently Amended) A method for manufacturing a device according to claim 2, wherein ~~the method further comprises a step of~~ forming a plurality of insulating ribs includes forming the insulating ribs in a stripe-like manner on the lower stripe-like electrodes, the insulating ribs extending in a direction perpendicular to the lower stripe-like electrodes;

~~wherein removing the at least one portion of the conductive film includes removing a portion of the conductive film from over the insulating ribs and includes using a radiation method~~.

10. (Currently Amended) A method for manufacturing a device according to claim [[8]]1, wherein the step of forming the plurality of ribs on the first electrode comprises arranging the plurality of ribs in laterally spaced rows parallel to each other.

11. (Currently Amended) A method for manufacturing a device according to claim [[8]]1, wherein the step of forming the plurality of ribs on the ~~at least one~~ first electrode comprises heating the ribs to cross-link the material of the ribs.

12. (Previously Presented) A method for manufacturing a device according to claim 11, wherein the plurality of ribs are made of a photoresist and are subjected to heat of approximately 220°C.

13. (Currently Amended) A method for manufacturing a device according to claim [[8]]1, wherein the step of forming the plurality of ribs on the first electrode comprises chamfering the edges of the ribs opposite to the first electrode.

14. (Canceled)

15. (Currently Amended) A method for manufacturing a device according to claim [[8]]1, wherein removing the at least one portion of the second conductive film comprises removing parts of an insulating rib thereby shaping the insulating rib into a "U"-shape.

16. (Currently Amended) An organic electro-luminescent device comprising:

a substrate;

at least one lower electrode arranged on the substrate and formed of a lower conductive film;

a plurality of insulating members each comprising a valley and consisting at least partially of an insulating material and arranged on the lower electrode;

at least one organic layer formed of an organic electro-luminescent medium and arranged at least between two adjacent insulating members; and

upper electrodes made of a second conductive film deposited over the at least one organic layer.

17. (Currently Amended) A device according to claim 16, ~~having~~ wherein the lower electrode is one of a plurality of strip-like lower electrodes.

18. (Currently Amended) A device according to claim 17, ~~having~~ further comprising a plurality of stripe-like isolating members extending in a direction perpendicular to the lower electrodes.

19. (Currently Amended) A device according to claim 16, wherein the insulating ~~member comprises~~ members form structures that comprise portions of the organic electroluminescent medium.

20. (Currently Amended) A device according to claim 16, wherein the insulating material forms insulating ribs on the lower electrode.

21. (Currently Amended) A ~~display~~ device according to claim 16, wherein the insulating material forms insulating ribs on the lower electrode and the organic electro-luminescent medium is over the insulating ribs.

22. (Currently Amended) A device according to claim 16, wherein the insulating material forms insulating ribs on the lower electrode, the organic electro-luminescent medium is over the insulating ~~rib~~ ribs and part of the second conductive film is over the organic electro-luminescent medium.

23. (Currently Amended) A device according to claim 16, wherein the insulating member is in the shape of a "U" and a base of the "U" is closer to the electrode than ends of legs of the "U".

24. (Previously Presented) A device according to claim 23, wherein the ends of the legs of the "U" comprise the medium of the at least one organic layer.

25. (Currently Amended) A device according to claim 23, wherein the ends of the legs of the "U" comprise material of the second conductive film.